



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

STK672-642A-E — Thick-Film Hybrid IC 2-phase Stepping Motor Driver

Overview

The STK672-642A-E is a hybrid IC for use as a unipolar, 2-phase stepping motor driver with PWM current control.

Applications

- Office photocopiers, printers, etc.

Features

- Built-in overcurrent detection function (output current OFF).
- Built-in overheat detection function (output current OFF).
- If either over-current or overheat detection function is activated, the FAULT signal (active low) is output.
- Built-in power on reset function.
- The motor speed is controlled by the frequency of an external clock signal.
- 2 phase or 1-2 phase excitation switching function.
- Using either or both edges of the clock signal switching function.
- Phase is maintained even when the excitation mode is switched.
- Rotational direction switching function.
- Supports schmitt input for 2.5V high level input.
- Incorporating a current detection resistor (0.089Ω: resistor tolerance $\pm 2\%$), motor current can be set using two external resistors.
- The ENABLE pin can be used to cut output current while maintaining the excitation mode.
- With a wide current setting range, power consumption can be reduced during standby.
- No motor sound is generated during hold mode due to external excitation current control.
- Miniature package (provides pin compatibility with STK672-640A-E)

■ Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment (home appliances, AV equipment, communication device, office equipment, industrial equipment etc.). The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for applications outside the standard applications of our customer who is considering such use and/or outside the scope of our intended standard applications, please consult with us prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.

■ Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

STK672-642A-E

Specifications

Absolute Maximum Ratings at $T_c = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	unit
Maximum supply voltage 1	V_{CC} max	No signal	52	V
Maximum supply voltage 2	V_{DD} max	No signal	-0.3 to +6.0	V
Input voltage	V_{IN} max	Logic input pins	-0.3 to +6.0	V
Output current 1	I_{OP} max	10 μ A, 1 pulse (resistance load)	20	A
Output current 2	I_{OH} max	$V_{DD}=5\text{V}$, $\text{CLOCK}\geq 200\text{Hz}$	4	A
Output current 3	I_{OF} max	Pin16 output current	10	mA
Allowable power dissipation 1	P_{dMF} max	With an arbitrarily large heat sink. Per MOSFET	8.3	W
Allowable power dissipation 2	P_{dPK} max	No heat sink	2.8	W
Operating substrate temperature	T_c max		105	$^\circ\text{C}$
Junction temperature	T_j max		150	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to +125	$^\circ\text{C}$

Allowable Operating Ranges at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	unit
Operating supply voltage 1	V_{CC}	With signals applied	10 to 42	V
Operating supply voltage 2	V_{DD}	With signals applied	5 \pm 5%	V
Input high voltage	V_{IH}	Pins 10, 12, 13, 14, 15, 17	2.5 to V_{DD}	V
Input low voltage	V_{IL}	Pins 10, 12, 13, 14, 15, 17	0 to 0.8	V
Output current 1	I_{OH1}	$T_c=105^\circ\text{C}$, $\text{CLOCK}\geq 200\text{Hz}$, Continuous operation, duty=100%	3.0	A
Output current 2	I_{OH2}	$T_c=80^\circ\text{C}$, $\text{CLOCK}\geq 200\text{Hz}$, Continuous operation, duty=100%, See the motor current (I_{OH}) derating curve	3.3	A
CLOCK frequency	f_{CL}	Minimum pulse width: at least 10 μ s	0 to 50	kHz
Phase driver withstand voltage	V_{DSS}	$I_D=1\text{mA}$ ($T_c=25^\circ\text{C}$)	100min	V
Recommended operating substrate temperature	T_c	No condensation	0 to 105	$^\circ\text{C}$
Recommended V_{ref} range	V_{ref}	$T_c=105^\circ\text{C}$	0.14 to 1.31	V

Refer to the graph for each conduction-period tolerance range for the output current and brake current.

Electrical Characteristics at $T_c=25^\circ\text{C}$, $V_{CC}=24\text{V}$, $V_{DD}=5.0\text{V}$

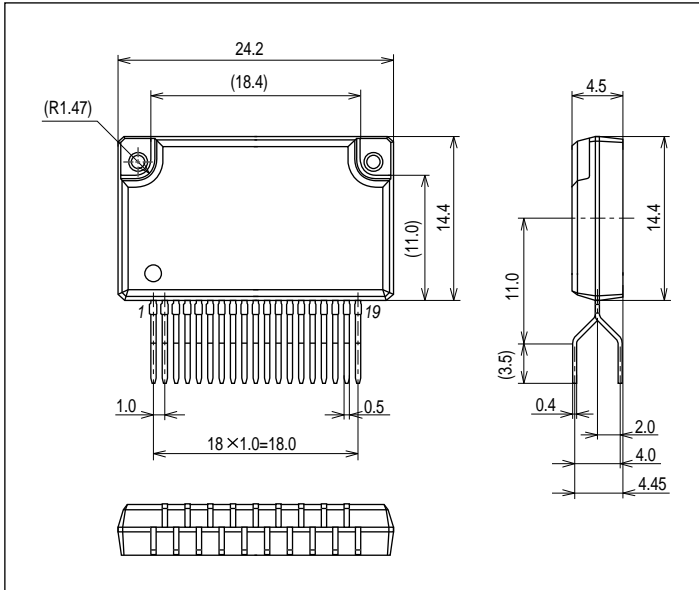
Parameter	Symbol	Conditions	min	typ	max	unit
V_{DD} supply current	I_{CCO}	Pin 9 current $\text{CLOCK}=\text{GND}$		4.4	8	mA
Output average current	I_{oave}	$R/L=1\Omega/0.62\text{mH}$ in each phase	0.519	0.625	0.731	A
FET diode forward voltage	V_{df}	$I_f=1\text{A}$ ($R_L=23\Omega$)		0.83	1.5	V
Output saturation voltage	V_{sat}	$R_L=23\Omega$		0.20	0.33	V
Input high voltage	V_{IH}	Pins 10, 12, 13, 14, 15, 17	2.5			V
Input low voltage	V_{IL}	Pins 10, 12, 13, 14, 15, 17			0.8	V
FAULT low output voltage	V_{OLF}	Pin 16 ($I_O=5\text{mA}$)		0.25	0.5	V
5V level FAULT leakage current	I_{ILF}	Pin 16=5V			10	μA
5V level input current	I_{ILH}	Pins 10, 12, 13, 14, 15, 17=5V		50	75	μA
GND level input current	I_{ILL}	Pins 10, 12, 13, 14, 15, 17=GND			10	μA
V_{ref} input bias current	I_{IB}	Pin 19=1.0V		10	15	μA
PWM frequency	f_c		29	45	61	kHz
Overheat detection temperature	TSD	Design guarantee		144		$^\circ\text{C}$

* I_{oave} values are for when the lead frame of the product is soldered to the mounting substrate.

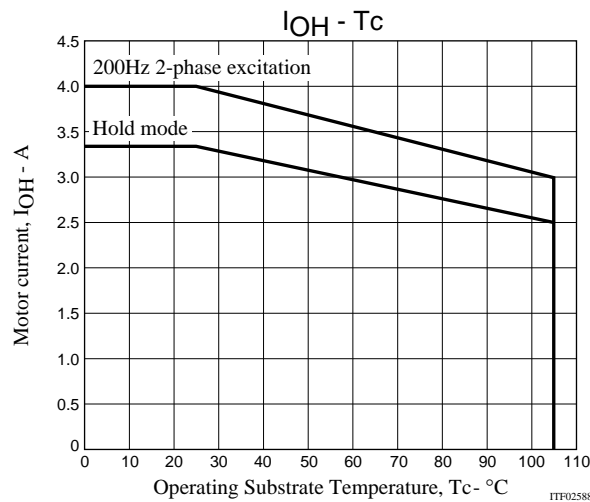
Notes: A fixed-voltage power supply must be used.

Package Dimensions

unit:mm (typ)



Derating curve of motor current, I_{OH} , vs. Operating substrate temperature, T_c

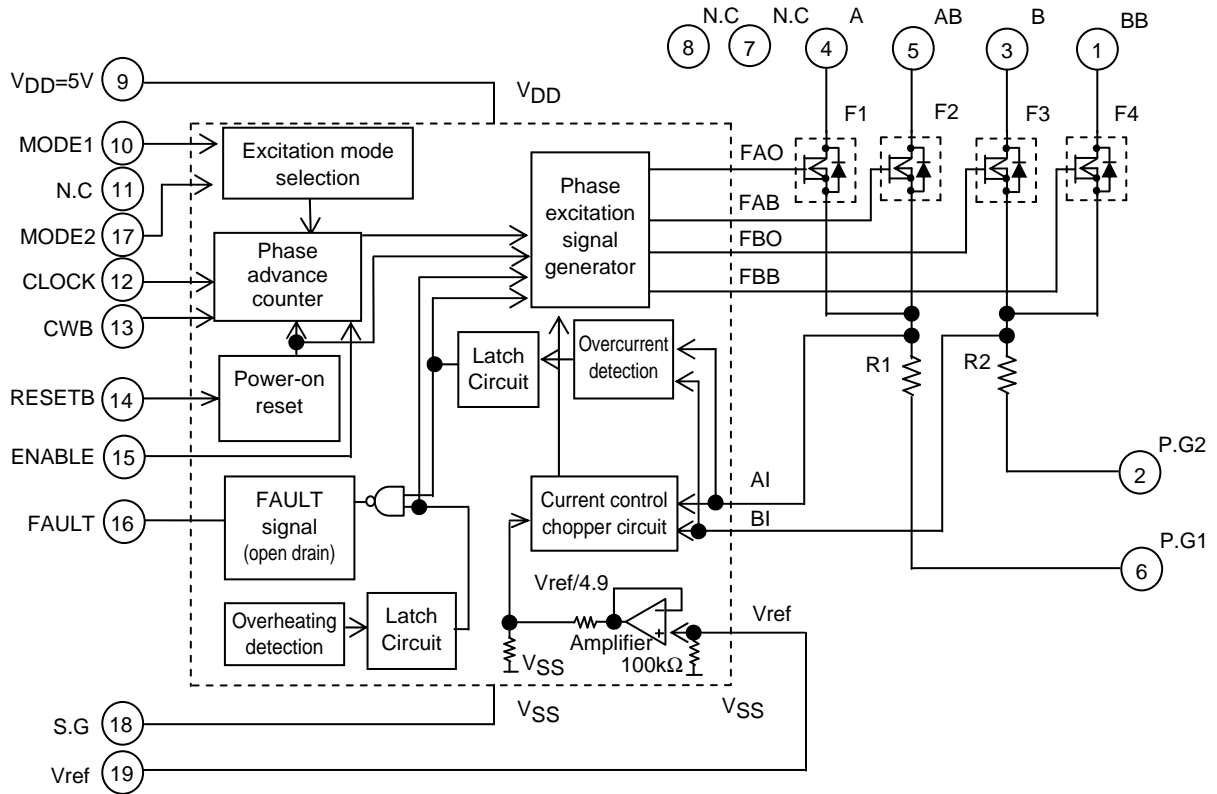


Notes

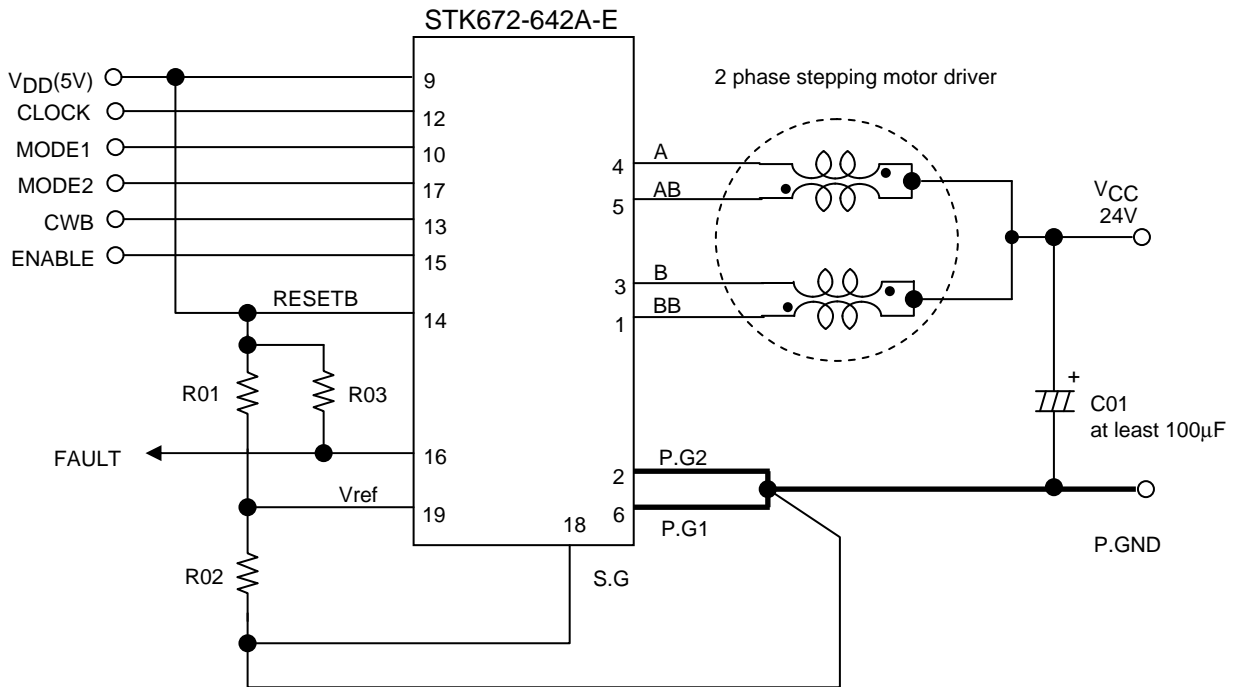
- The current range given above represents conditions when output voltage is not in the avalanche state.
- If the output voltage is in the avalanche state, see the allowable avalanche energy for STK672-6** series hybrid ICs given in a separate document.
- The operating substrate temperature, T_c , given above is measured while the motor is operating.
- Because T_c varies depending on the ambient temperature, T_a , the value of I_{OH} , and the continuous or intermittent operation of I_{OH} , always verify this value using an actual set.
- The T_c temperature should be checked in the center of the metal surface of the product package.

STK672-642A-E

Block Diagram



Sample Application Circuit



Precautions

[GND wiring]

- To reduce noise on the 5V system, be sure to place the GND of C01 in the circuit given above as close as possible to Pin 2 and Pin 6 of the hybrid IC. Also, to achieve accurate current settings, be sure to connect Vref GND to Pin 18 (S.G) used to set the current and to the point where P.G1 and P.G2 share a connection.

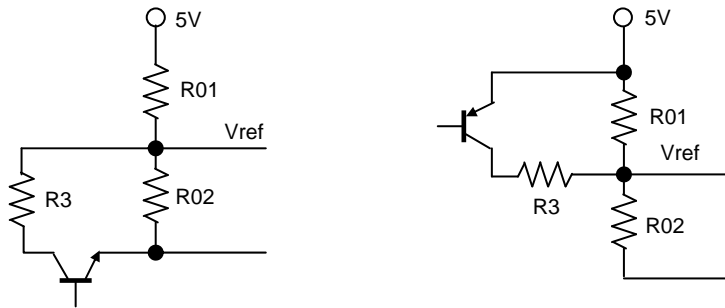
[Input pins]

- If V_{DD} is being applied, use care that each input pin does not apply a negative voltage less than -0.3V to S.G, Pin 18, and do not apply a voltage greater than or equal to V_{DD} voltage.
- Do not wire by connecting the circuit pattern on the P.C.B side to Pins 7, 8, or 11 on the N.C. shown in the internal block diagram.
- Apply 2.5V high level input to pins 10, 12, 13, 14, 15, and 17.
- Since the input pins do not have built-in pull-up resistors, when the open-collector type pins 10, 12, 13, 14, 15, and 17 are used as inputs, a 1 to 20kΩ pull-up resistor (to V_{DD}) must be used.

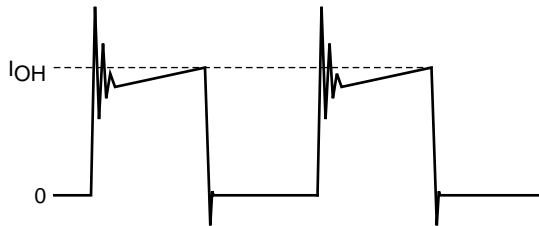
At this time, use a device for the open collector driver that has output current specifications that pull the voltage down to less than 0.8V at Low level (less than 0.8V at Low level when I_{OL}=5mA).

[Current setting Vref]

- Considering the specifications of the Vref input bias current, I_{IB}, a value of 1kΩ or less is recommended for R02. If the motor current is temporarily reduced, the circuit given below (STK672-630A-E, 632A-E: I_{OH}>0.2A, STK672-640A-E, 642A-E: I_{OH}>0.3A) is recommended.



- Motor current peak value I_{OH} setting



$$I_{OH} = (V_{ref} \div 4.9) \div R_s$$

The value of 4.9 in Equation above represents the Vref voltage as divided by a circuit inside the control IC.

$$V_{ref} = (R02 \div (R01 + R02)) \times 5V \text{ (or } 3.3V)$$

R_s is an internal current detection resistor value of the hybrid IC.

R_s = 0.089Ω when using the STK672-642A-E

STK672-642A-E

[Smoke Emission Precautions]

If Pin 18 (S.G terminal) is attached to the PCB without using solder, overcurrent may flow into the MOSFET at V_{CCON} (24V ON), causing to emit smoke because 5V circuits cannot be controlled.

In addition, as long as one of the output Pins, 1, 3, 4, or 5, is open, inductance energy stored in the motor results in electrical stress on the driver, possibly resulting in the emission of smoke.

Input Pin Functions

Pin Name	Pin No.	Function	Input Conditions When Operating
CLOCK	12	Reference clock for motor phase current switching	Operates on the rising edge of the signal (MODE2=H)
MODE1	10	Excitation mode selection	Low: 2-phase excitation High: 1-2 phase excitation
MODE2	17		High: Rising edge Low: Rising and falling edge
CWB	13	Motor direction switching	Low: CW (forward) High: CCW (reverse)
RESETB	14	System reset Initial state of A and BB phase excitation in the timing charts is set by switching from low to high.	A reset is applied by a low level
ENABLE	15	The A, AB, B, and BB outputs are turned off, and after operation is restored by returning the ENABLE pin to the high level, operation continues with the same excitation timing as before the low-level input.	The A, AB, B, and BB outputs are turned off by a low-level input.

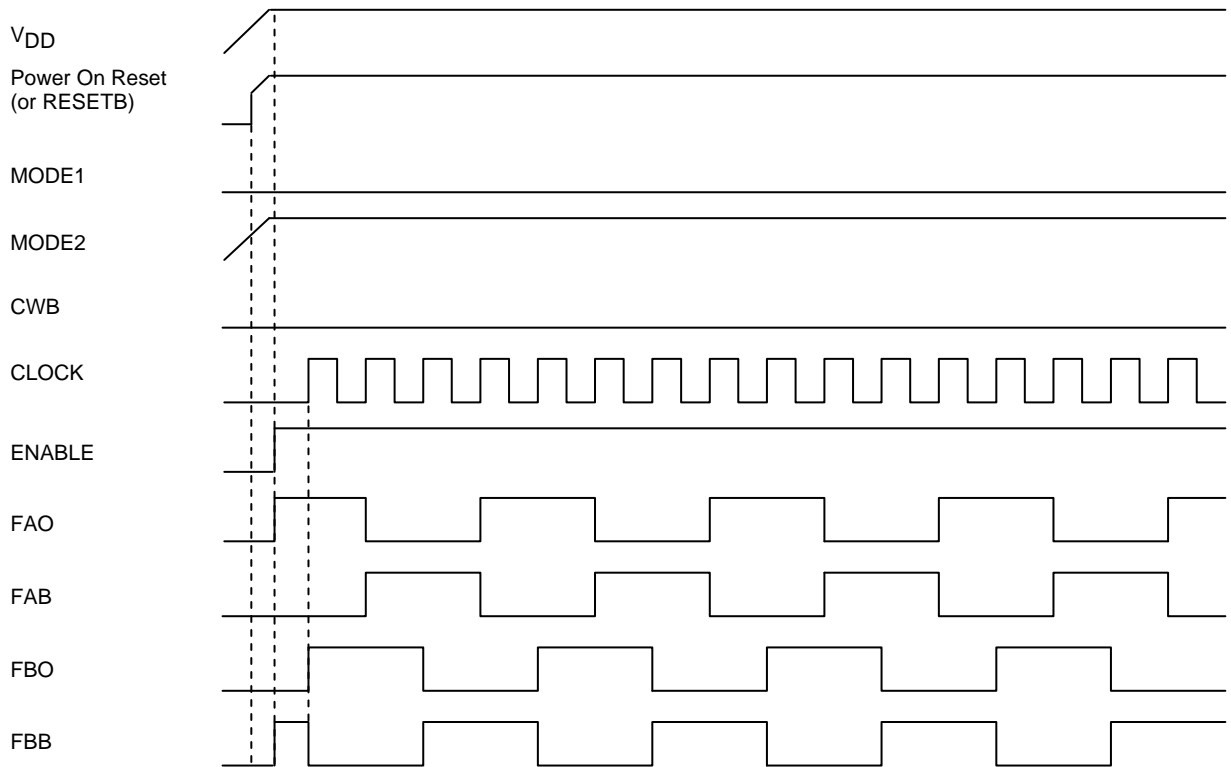
Output Pin Functions

Pin Name	Pin No.	Function	Input Conditions When Operating
FAULT	16	Monitor pin used when over-current detection or overheat detection function is activated.	Low level is output when detected.

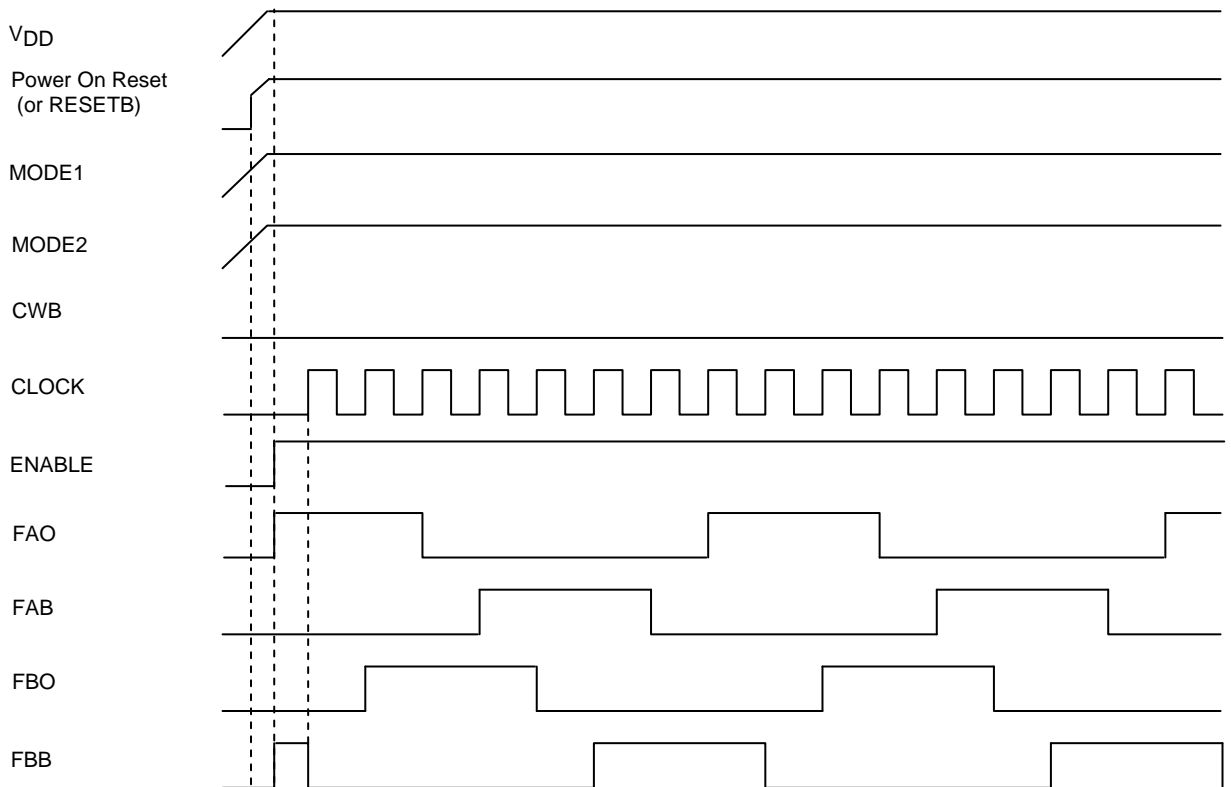
Note: See the timing chart for the concrete details on circuit operation.

Timing Charts

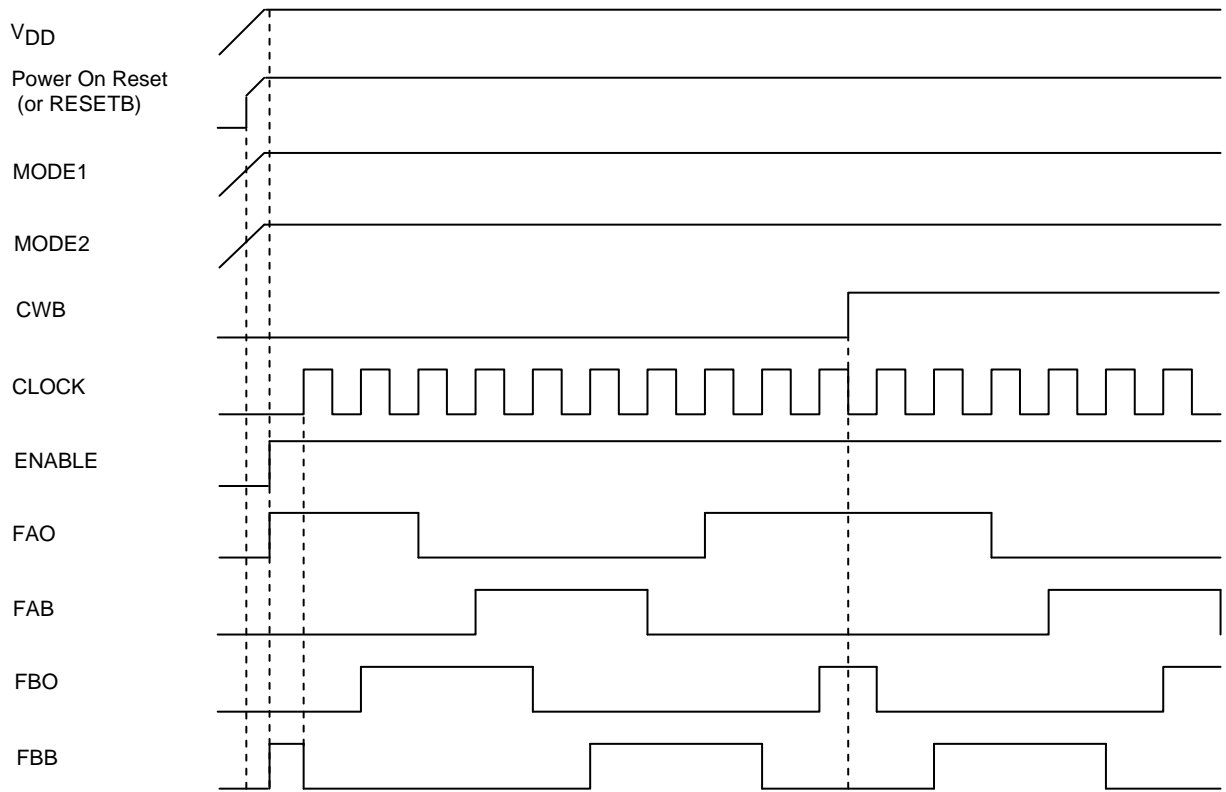
2-phase excitation



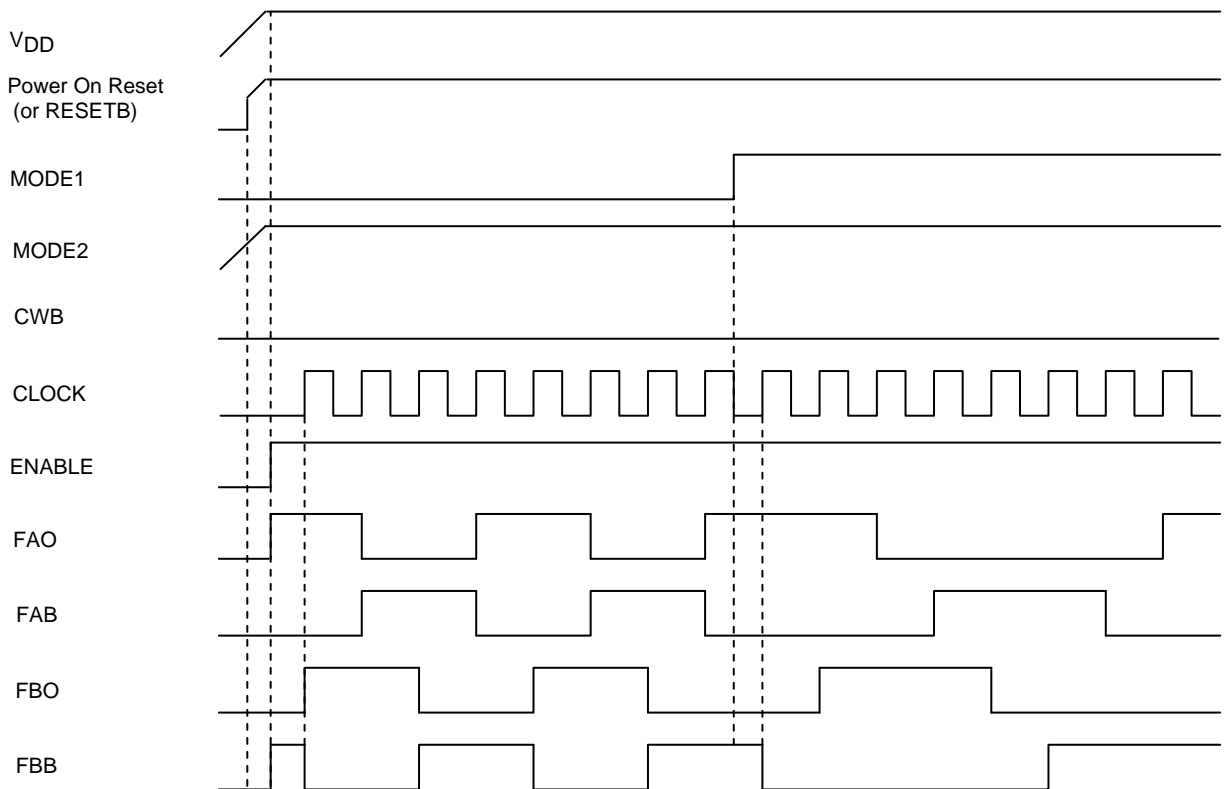
1-2 phase excitation



1-2 phase excitation (CWB)

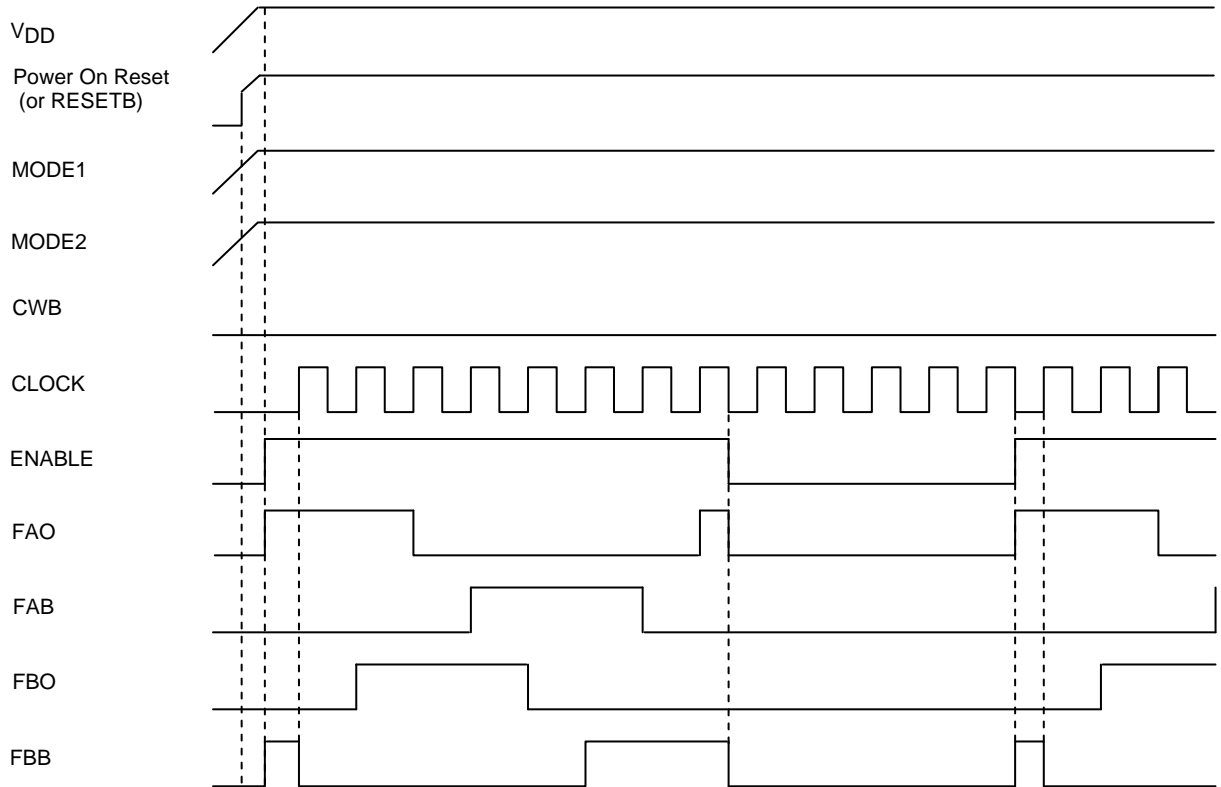


2 phase excitation → Switch to 1-2 phase excitation

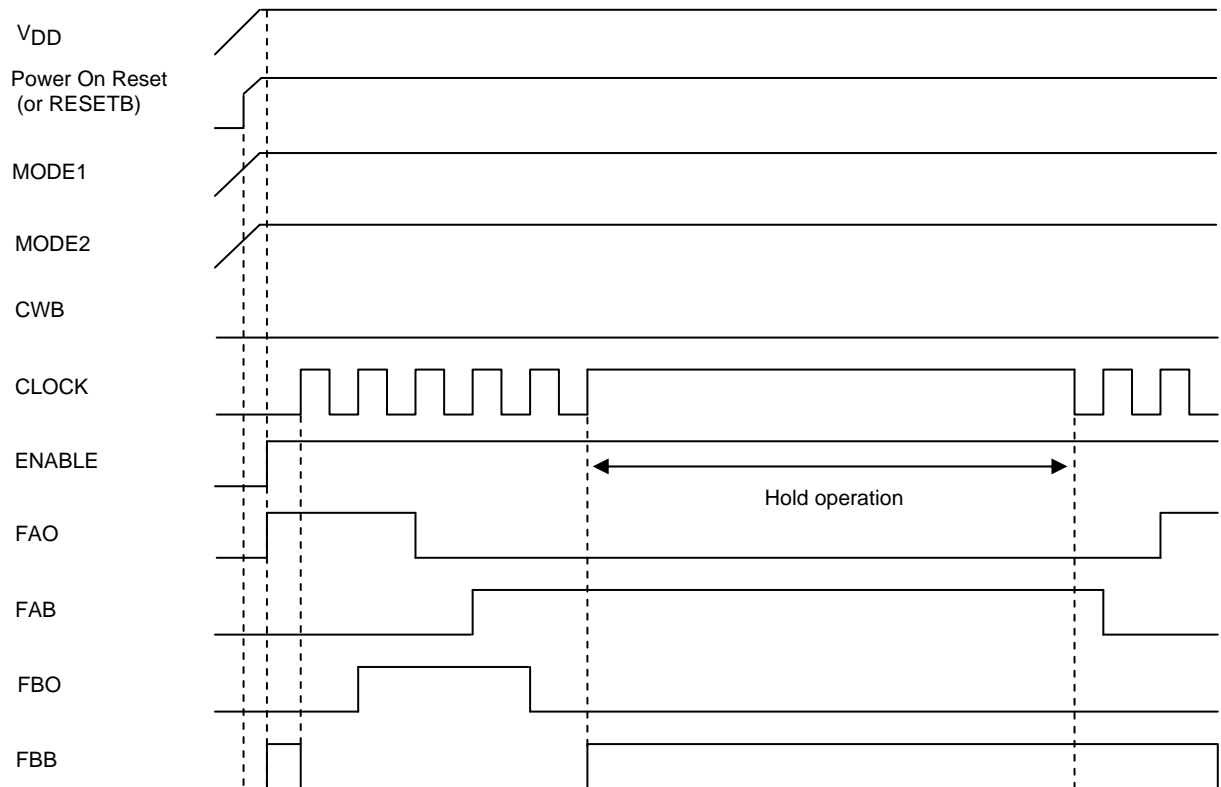


STK672-642A-E

1-2 phase excitation (ENABLE)

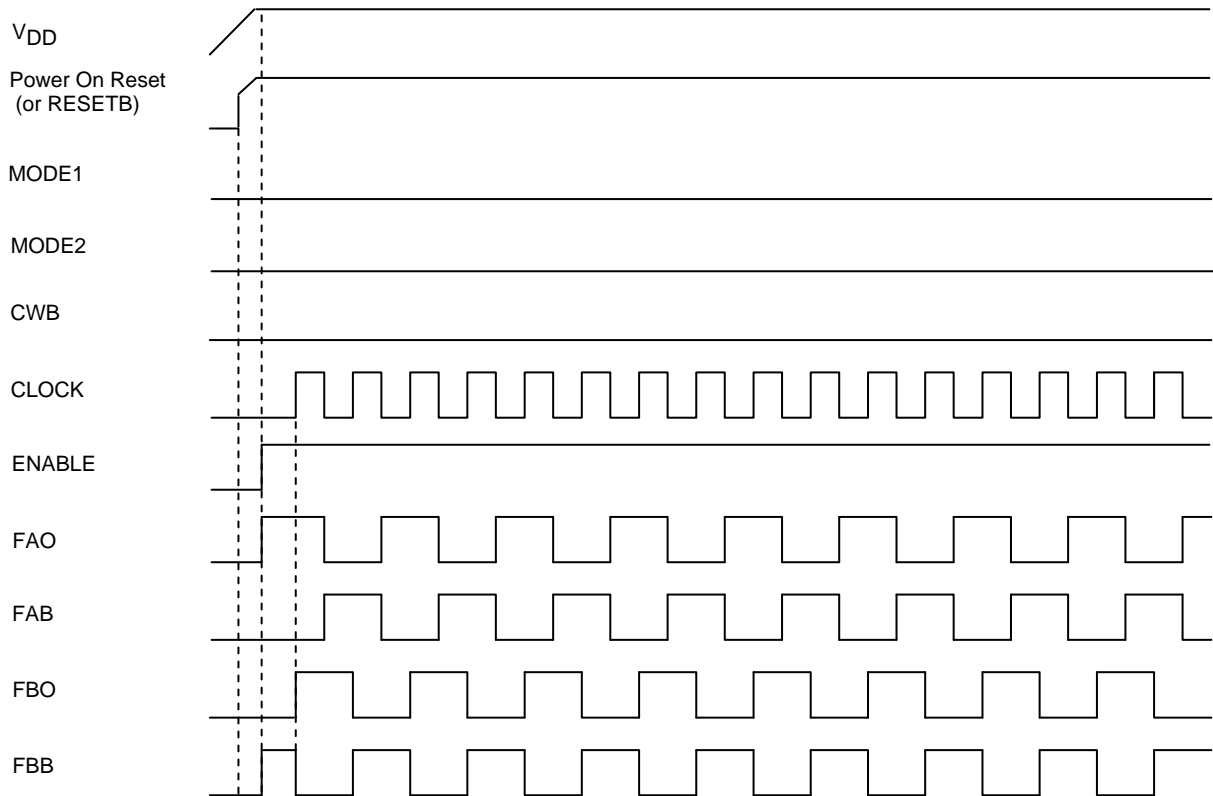


1-2 phase excitation (Hold operation results during fixed CLOCK)

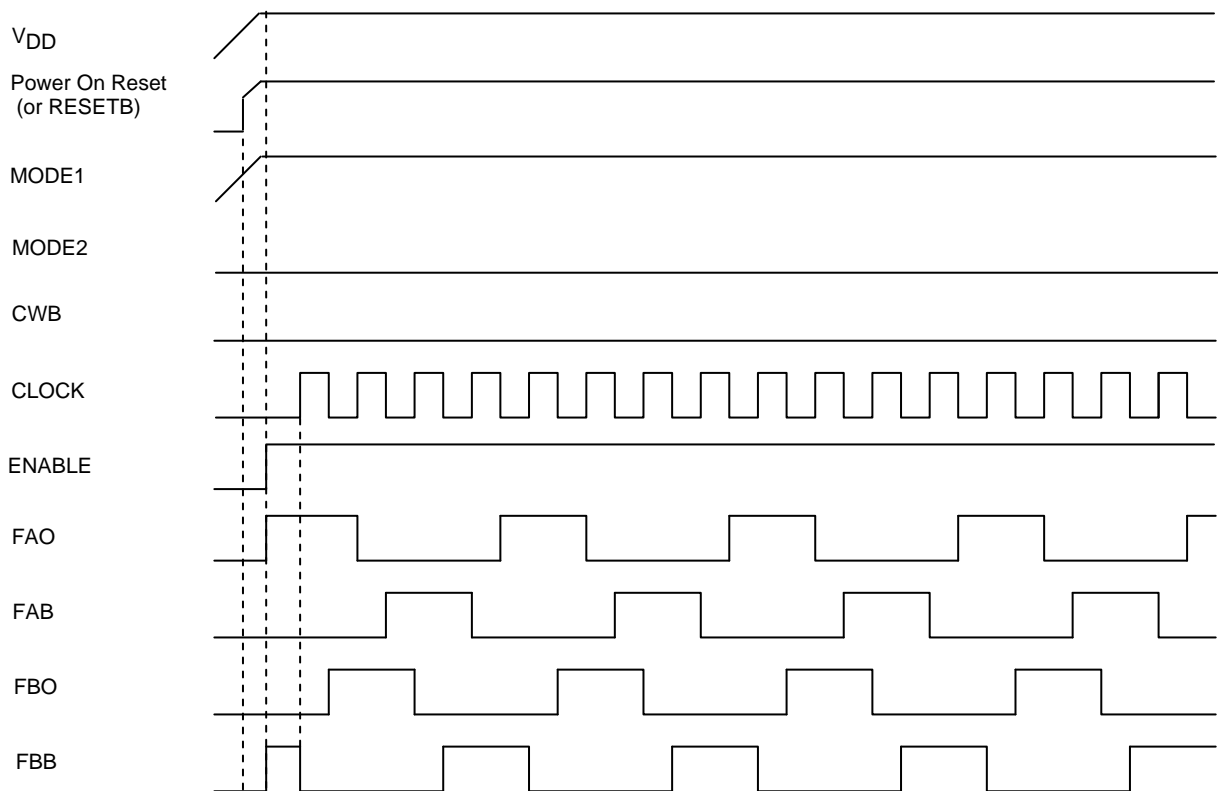


STK672-642A-E

2 phase excitation (MODE 2)



1-2 phase excitation (MODE 2)



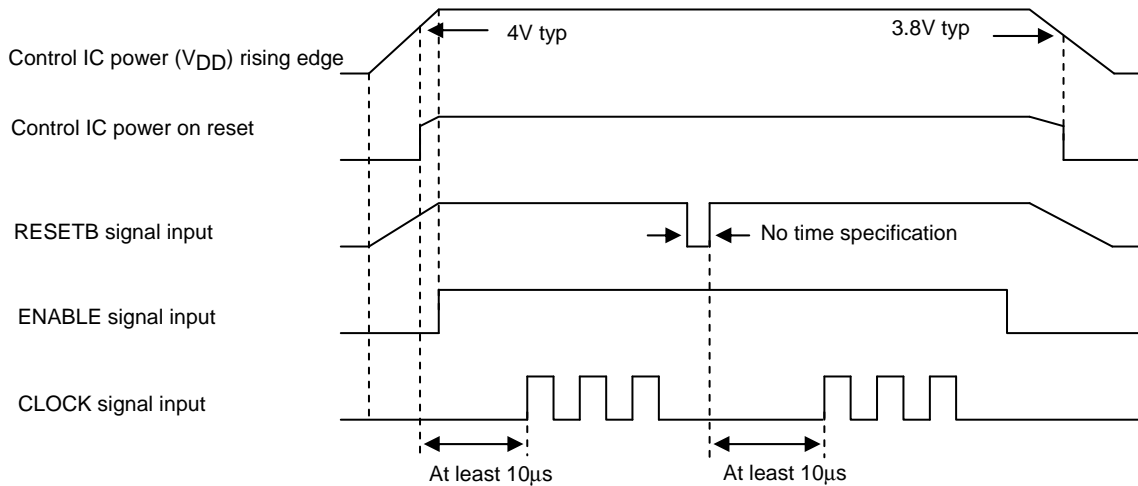
Usage Notes

1. Input signal functions and timing

[ENABLE, CLOCK and power on reset, RESETB (Input signal timing when power is first applied)]

The control IC of the driver is equipped with a power on reset function capable of initializing internal IC operations when power is supplied. A 4V typ setting is used for power on reset. Because the specification for the MOSFET gate voltage is $5V \pm 5\%$, conduction of current to output at the time of power on reset adds electromotive stress to the MOSFET due to lack of gate voltage. To prevent electromotive stress, be sure to set ENABLE=Low while V_{DD} , which is outside the operating supply voltage, is less than 4.75V.

In addition, if the RESETB terminal is used to initialize output timing, be sure to allow at least 10 μ s until CLOCK input.



ENABLE, CLOCK, and RESETB Signals Input Timing

[CLOCK (Phase switching clock)]

- Input frequency: DC to 50kHz
- Minimum pulse width: 10 μ s
- MODE2=1(High) Signals are read on the rising edge.
- MODE2=0(Low) Signals are read on the rising and falling edges.

[CWB (Motor direction setting)]

The direction of rotation is switched by setting CWB to 1 (high) or 0 (low).

See the timing charts for details on the operation of the outputs.

Note: The state of the CWB input must not be changed during the 6.25 μ s period before and after the rising edge of the CLOCK input.

[ENABLE (Forcible on/off control of the A, AB, B, and BB outputs, and hybrid IC internal operation)]

ENABLE=1: Normal operation

ENABLE=0: Outputs A, AB, B, and BB forced to the off state.

If, during the state where CLOCK signal input is provided, the ENABLE pin is set to 0 and then is later restored to the 1 state, the IC will resume operation with the excitation timing continued from before the point ENABLE was set to 0.

If sudden stop is applied to the CLOCK signal used for motor rotation, the motor axis may advance beyond the theoretical position due to inertia. To stop at the theoretical position, the SLOW DOWN setting for gradually slowing the CLOCK cycle is required.

STK672-642A-E

[MODE1 and MODE2 (Excitation mode selection)]

MODE1=0: 2-phase excitation

MODE2=1: Rising edge of CLOCK

MODE1=1: 1-2 phase excitation

MODE2=0: Rising and falling edges of CLOCK

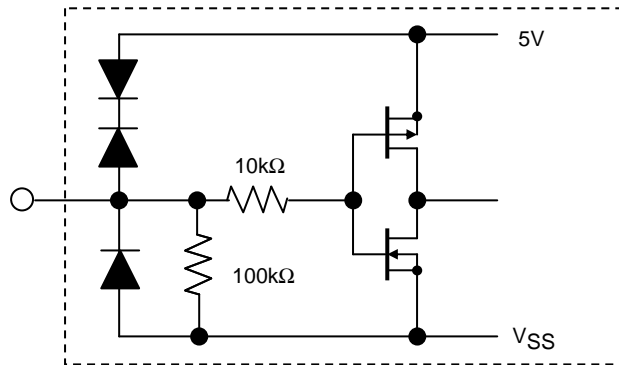
See the timing charts for details on output operation in these modes.

Note: The state of the MODE input must not be changed during the 5 μ s period before and after the rising edge of the CLOCK input.

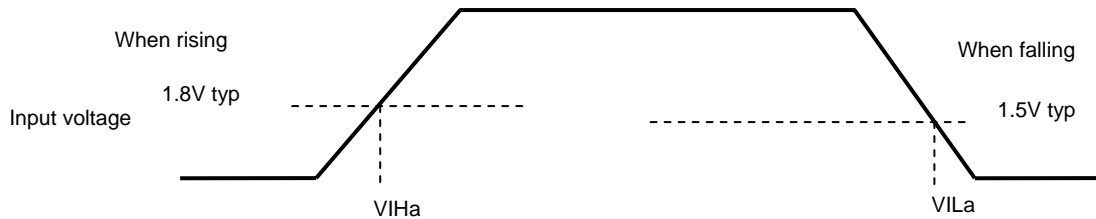
[Configuration of Each Input Pin]

<Configuration of the MODE1, MODE2, CLOCK, CWB, ENABLE, and RESETB input pins>

Input pins: Pin 10, 17, 12, 13, 15, and 14



All input pins of this driver support schmitt input. Typ specifications at $T_c = 25^\circ\text{C}$ are given below. Hysteresis voltage is 0.3V ($V_{IHa} - V_{ILa}$).

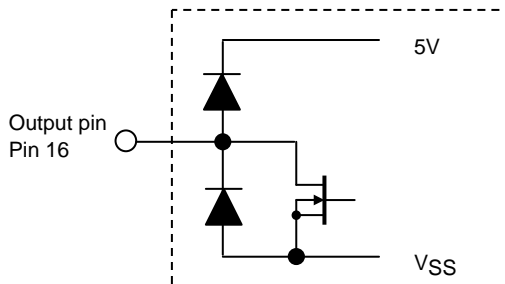


Input voltage specifications are as follows.

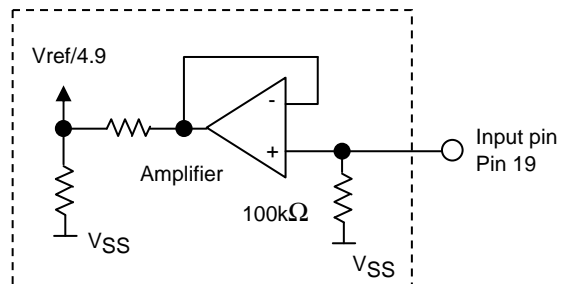
$V_{IH} = 2.5\text{V min}$

$V_{IL} = 0.8\text{V max}$

<Configuration of the FAULT Input Pin>



<Configuration of the Vref Input Pin>



The internal impedance, 100k Ω , is designed so that the increase in current is prevented while Pin 19 is open.

The recommended Vref voltage is 0.14V or higher because the output offset voltage of Vref/4.9 amplifier cannot be controlled down to 0V

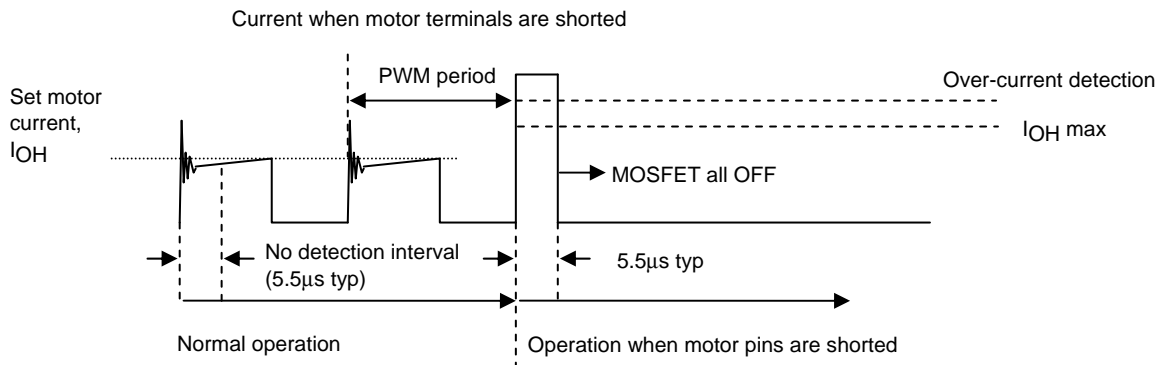
2. Overcurrent Detection and Overheat Detection Functions

Each detection function operates using a latch system and turns output off. Because a RESET signal is required to restore output operations, once the power supply, V_{DD} , is turned off, you must either again apply power on reset with V_{DDON} or apply a $RESETB=High \rightarrow Low \rightarrow High$ signal.

[Overcurrent detection]

This hybrid IC is equipped with a function for detecting overcurrent that arises when the motor burns out or when there is a short between the motor terminals.

Overcurrent detection occurs at 5.5A typ with the STK672-642A-E.



Overcurrent detection begins after an interval of no detection (a dead time of 5.5µs typ) during the initial ringing part during PWM operations. The no detection interval is a period of time where overcurrent is not detected even if the current exceeds I_{OH} .

[Overheat detection]

Rather than directly detecting the temperature of the semiconductor device, overheat detection detects the temperature of the aluminum substrate (144°C typ).

Within the allowed operating range recommended in the specification manual, if a heat sink attached for the purpose of reducing the operating substrate temperature, T_c , comes loose, the semiconductor can operate without breaking.

However, we cannot guarantee operations without breaking in the case of operations other than those recommended, such as operations at a current exceeding $I_{OH\ max}$ that occurs before overcurrent detection is activated.

3. Calculating Internal Power Loss

The average internal power loss in each excitation mode of the STK672-642A-E can be calculated from the following formulas.

Each excitation mode

2-phase excitation mode

$$2PdAV_{ex} = (V_{sat} + V_{df}) \times 0.5 \times \text{CLOCK} \times I_{OH} \times t_2 + 0.5 \times \text{CLOCK} \times I_{OH} \times (V_{sat} \times t_1 + V_{df} \times t_3)$$

1-2 Phase excitation mode

$$1-2PdAV_{ex} = (V_{sat} + V_{df}) \times 0.25 \times \text{CLOCK} \times I_{OH} \times t_2 + 0.25 \times \text{CLOCK} \times I_{OH} \times (V_{sat} \times t_1 + V_{df} \times t_3)$$

Motor hold mode

$$\text{HoldPdAV}_{ex} = (V_{sat} + V_{df}) \times I_{OH}$$

V_{sat} : Combined voltage represented by the R_{on} voltage drop+shunt resistor

V_{df} : Combined voltage represented by the MOSFET body diode+shunt resistor

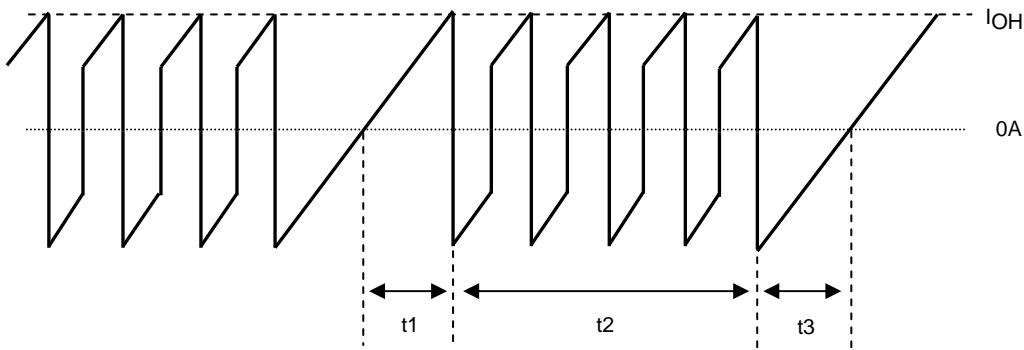
CLOCK: Input CLOCK (CLOCK pin signal frequency)

t_1 , t_2 , and t_3 represent the waveforms shown in the figure below.

t_1 : Time required for the winding current to reach the set current (I_{OH})

t_2 : Time in the constant current control (PWM) region

t_3 : Time from end of phase input signal until inverse current regeneration is complete



Motor COM Current Waveform Model

$$t_1 = (-L / (R + 0.20)) \ln (1 - ((R + 0.20) / V_{CC}) \times I_{OH})$$

$$t_3 = (-L / R) \ln ((V_{CC} + 0.20) / (I_{OH} \times R + V_{CC} + 0.20))$$

V_{CC} : Motor supply voltage (V)

L: Motor inductance (H)

R: Motor winding resistance (Ω)

I_{OH} : Motor set output current crest value (A)

Relationship of CLOCK, t_1 , t_2 , and t_3 in each excitation mode

2-phase excitation mode: $t_2 = (2 / \text{CLOCK}) - (t_1 + t_3)$

1-2 phase excitation mode: $t_2 = (3 / \text{CLOCK}) - t_1$

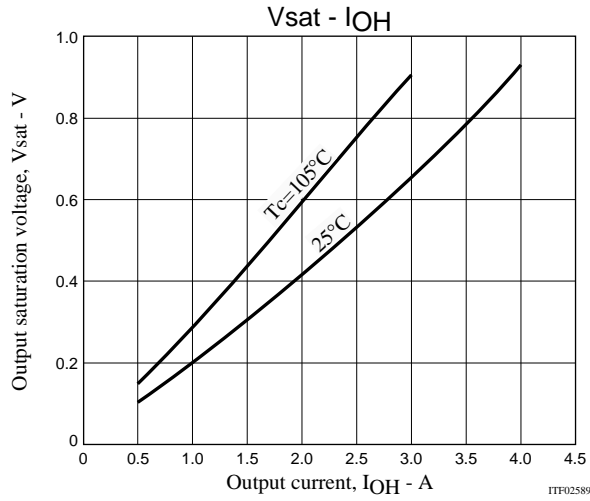
For V_{sat} and V_{df} , be sure to substitute values from the graphs of V_{sat} vs. I_{OH} and V_{df} vs. I_{OH} while the set current value is I_{OH} .

Then, determine whether a heat sink is required by comparing with the graph of ΔT_c vs. Pd based on the average HIC power loss calculated.

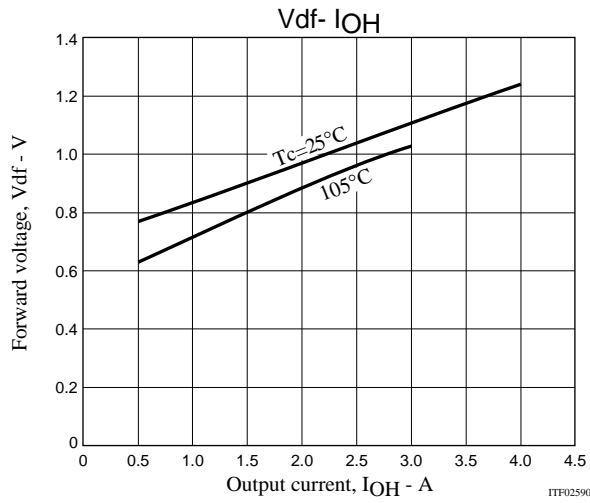
When designing a heat sink, refer to the section “Thermal design” found on the next page. The average HIC power loss, PdAV, described above does not have the avalanche’s loss. To include the avalanche’s loss, be sure to add Equation (2), “STK672-6** Allowable Avalanche Energy Value” to PdAV above. When using this IC without a fin always check for temperature increases in the set, because the HIC substrate temperature, T_c , varies due to effects of convection around the HIC.

STK672-642A-E

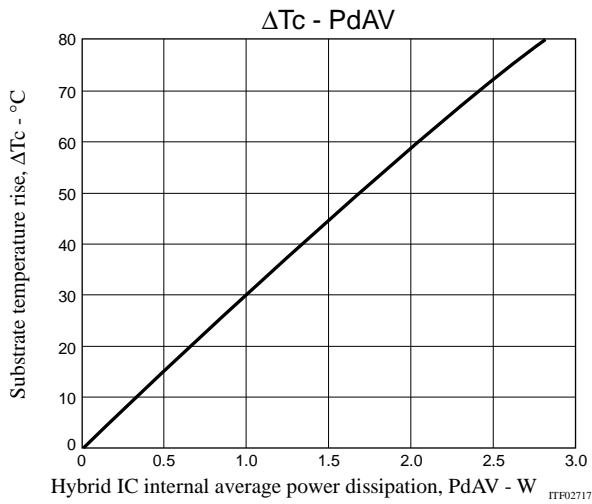
Output saturation voltage, V_{sat} - Output current, I_{OH}



Forward voltage, V_{df} - Output current, I_{OH}



Substrate temperature rise, ΔT_c (no heat sink) - Internal average power dissipation, P_{dAV}



4. Allowable Avalanche Energy Value

(1) Allowable Range in Avalanche Mode

When driving a 2-phase stepping motor with constant current chopping using an STK672-6** Series hybrid IC, the waveforms shown in Figure 1 below result for the output current, I_D , and voltage, V_{DS} .

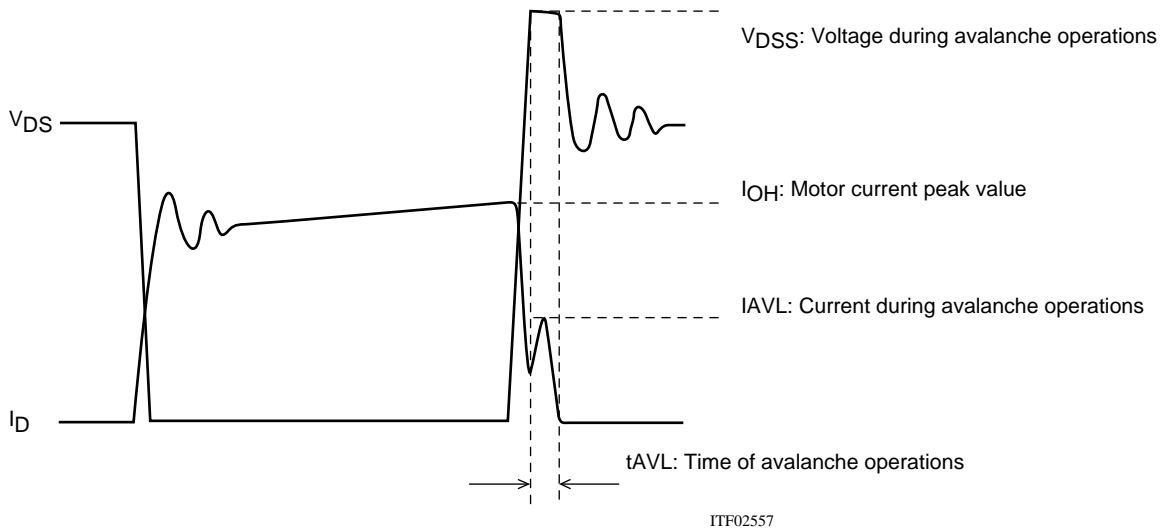


Figure 1 Output Current, I_D , and Voltage, V_{DS} , Waveforms 1 of the STK672-6** Series when Driving a 2-Phase Stepping Motor with Constant Current Chopping

When operations of the MOSFET built into STK672-6** Series ICs is turned off for constant current chopping, the I_D signal falls like the waveform shown in the figure above. At this time, the output voltage, V_{DS} , suddenly rises due to electromagnetic induction generated by the motor coil.

In the case of voltage that rises suddenly, voltage is restricted by the MOSFET V_{DSS} . Voltage restriction by V_{DSS} results in a MOSFET avalanche. During avalanche operations, I_D flows and the instantaneous energy at this time, E_{AVL1} , is represented by Equation (1).

$$E_{AVL1} = V_{DSS} \times I_{AVL} \times 0.5 \times t_{AVL} \text{ ----- (1)}$$

V_{DSS} : V units, I_{AVL} : A units, t_{AVL} : sec units

The coefficient 0.5 in Equation (1) is a constant required to convert the I_{AVL} triangle wave to a square wave.

During STK672-6** Series operations, the waveforms in the figure above repeat due to the constant current chopping operation. The allowable avalanche energy, E_{AVL} , is therefore represented by Equation (2) used to find the average power loss, P_{AVL} , during avalanche mode multiplied by the chopping frequency in Equation (1).

$$P_{AVL} = V_{DSS} \times I_{AVL} \times 0.5 \times t_{AVL} \times f_c \text{ ----- (2)}$$

f_c : Hz units (f_c is set to the PWM frequency of 50kHz.)

For V_{DSS} , I_{AVL} , and t_{AVL} , be sure to actually operate the STK672-6** Series and substitute values when operations are observed using an oscilloscope.

Ex. If $V_{DSS}=110V$, $I_{AVL}=1A$, $t_{AVL}=0.2\mu s$ when using a STK672-642A-E driver, the result is:

$$P_{AVL} = 110 \times 1 \times 0.5 \times 0.2 \times 10^{-6} \times 50 \times 10^3 = 0.55W$$

$V_{DSS}=110V$ is a value actually measured using an oscilloscope.

The allowable loss range for the allowable avalanche energy value, P_{AVL} , is shown in the graph in Figure 3. When examining the avalanche energy, be sure to actually drive a motor and observe the I_D , V_{DS} , and t_{AVL} waveforms during operation, and then check that the result of calculating Equation (2) falls within the allowable range for avalanche operations.

(2) I_D and V_{DS} Operating Waveforms in Non-avalanche Mode

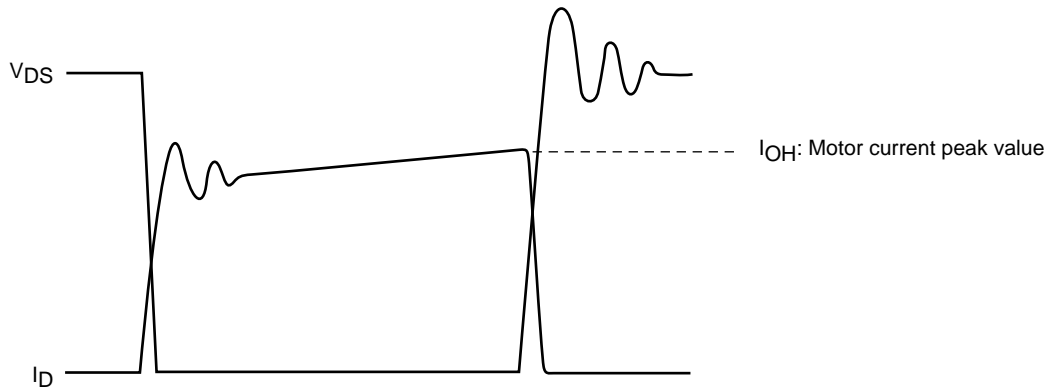
Although the waveforms during avalanche mode are given in Figure 1, sometimes an avalanche does not result during actual operations.

Factors causing avalanche are listed below.

- Poor coupling of the motor's phase coils (electromagnetic coupling of A phase and AB phase, B phase and BB phase).
- Increase in the lead inductance of the harness caused by the circuit pattern of the P.C. board and motor.
- Increases in V_{DSS} , t_{AVL} , and I_{AVL} in Figure 1 due to an increase in the supply voltage from 24V to 36V.

If the factors above are negligible, the waveforms shown in Figure 1 become waveforms without avalanche as shown in Figure 2.

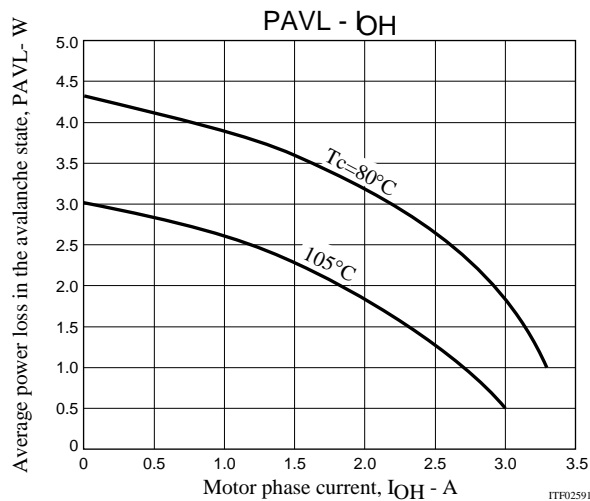
Under operations shown in Figure 2, avalanche does not occur and there is no need to consider the allowable loss range of $PAVL$ shown in Figure 3.



ITF02558

Figure 2 Output Current, I_D , and Voltage, V_{DS} , Waveforms 2 of the STK672-6** Series when Driving a 2-Phase Stepping Motor with Constant Current Chopping

Figure 3 Allowable Loss Range, $PAVL-I_{OH}$ During Avalanche Operations



ITF02591

Note:

The operating conditions given above represent a loss when driving a 2-phase stepping motor with constant current chopping.

Because it is possible to apply 3W or more at $I_{OH}=0A$, be sure to avoid using the MOSFET body diode that is used to drive the motor as a zener diode.

5. Thermal design

[Operating range in which a heat sink is not used]

Use of a heat sink to lower the operating substrate temperature of the HIC (Hybrid IC) is effective in increasing the quality of the HIC.

The size of heat sink for the HIC varies depending on the magnitude of the average power loss, PdAV, within the HIC. The value of PdAV increases as the output current increases. To calculate PdAV, refer to “Calculating Internal HIC Loss for the STK672-642A-E”.

Calculate the internal HIC loss, PdAV, assuming repeat operation such as shown in Figure 1 below, since conduction during motor rotation and off time both exist during actual motor operations,

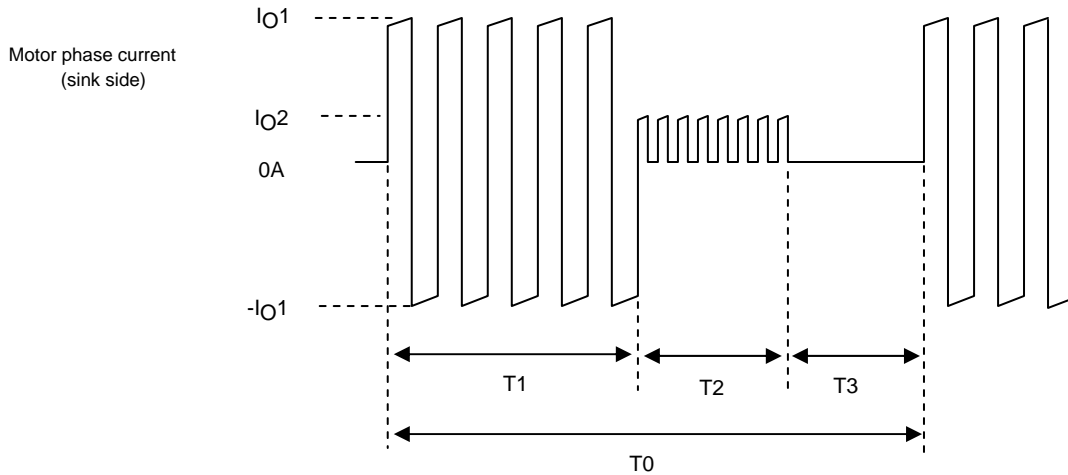


Figure 1 Motor Current Timing

T1: Motor rotation operation time

T2: Motor hold operation time

T3: Motor current off time

T2 may be reduced, depending on the application.

T0: Single repeated motor operating cycle

IO1 and IO2: Motor current peak values

Due to the structure of motor windings, the phase current is a positive and negative current with a pulse form.

Note that figure 1 presents the concepts here, and that the on/off duty of the actual signals will differ.

The hybrid IC internal average power dissipation PdAV can be calculated from the following formula.

$$PdAV = (T1 \times P1 + T2 \times P2 + T3 \times 0) \div T0 \text{ ----- (I)}$$

(Here, P1 is the PdAV for IO1 and P2 is the PdAV for IO2)

If the value calculated using Equation (I) is 1.5W or less, and the ambient temperature, Ta, is 60°C or less, there is no need to attach a heat sink. Refer to Figure 2 for operating substrate temperature data when no heat sink is used.

[Operating range in which a heat sink is used]

Although a heat sink is attached to lower Tc if PdAV increases, the resulting size can be found using the value of θc-a in Equation (II) below and the graph depicted in Figure 3.

$$\theta_{c-a} = (Tc \text{ max} - Ta) \div PdAV \text{ ----- (II)}$$

Tc max: Maximum operating substrate temperature = 105°C

Ta: HIC ambient temperature

Although a heat sink can be designed based on equations (I) and (II) above, be sure to mount the HIC in a set and confirm that the substrate temperature, Tc, is 105°C or less.

The average HIC power loss, PdAV, described above represents the power loss when there is no avalanche operation. To add the loss during avalanche operations, be sure to add Equation (2), “Allowable STK672-6** Avalanche Energy Value”, to PdAV.

Figure 2 Substrate temperature rise, ΔT_c (no heat sink) - Internal average power dissipation, PdAV

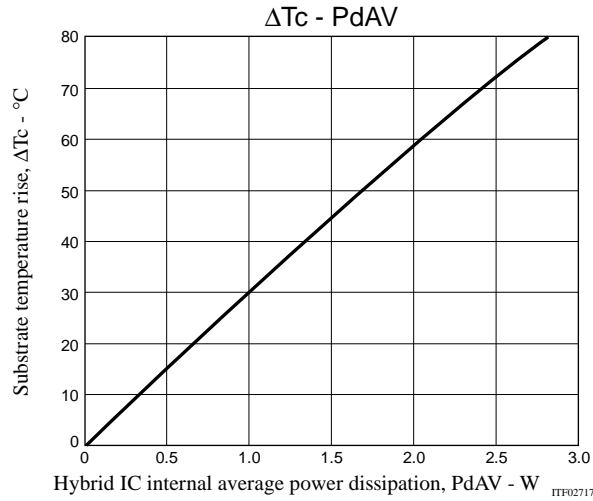
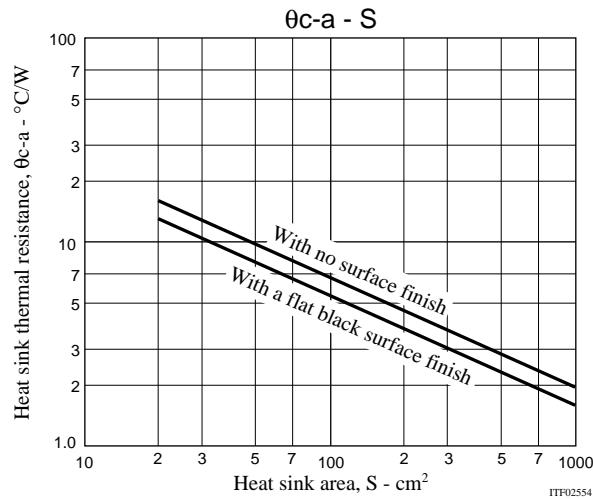


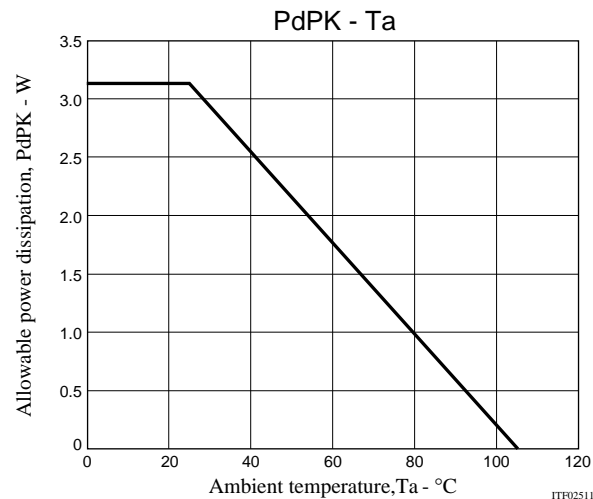
Figure 3 Heat sink area (Board thickness: 2mm) - θ_{c-a}



6. Mitigated Curve of Package Power Loss, PdPK, vs. Ambient Temperature, Ta

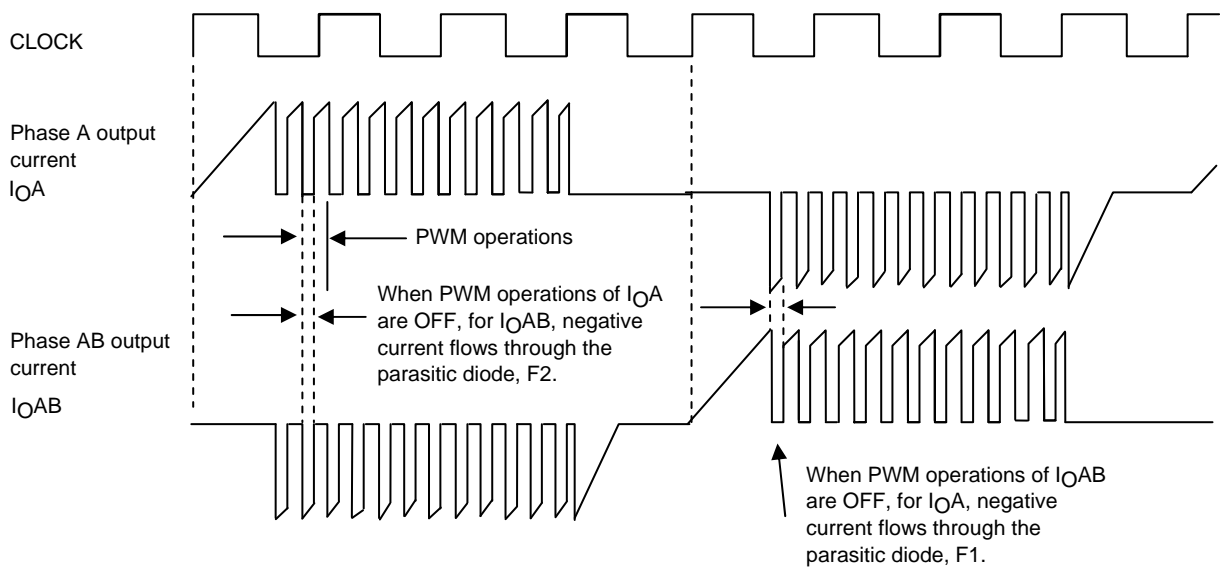
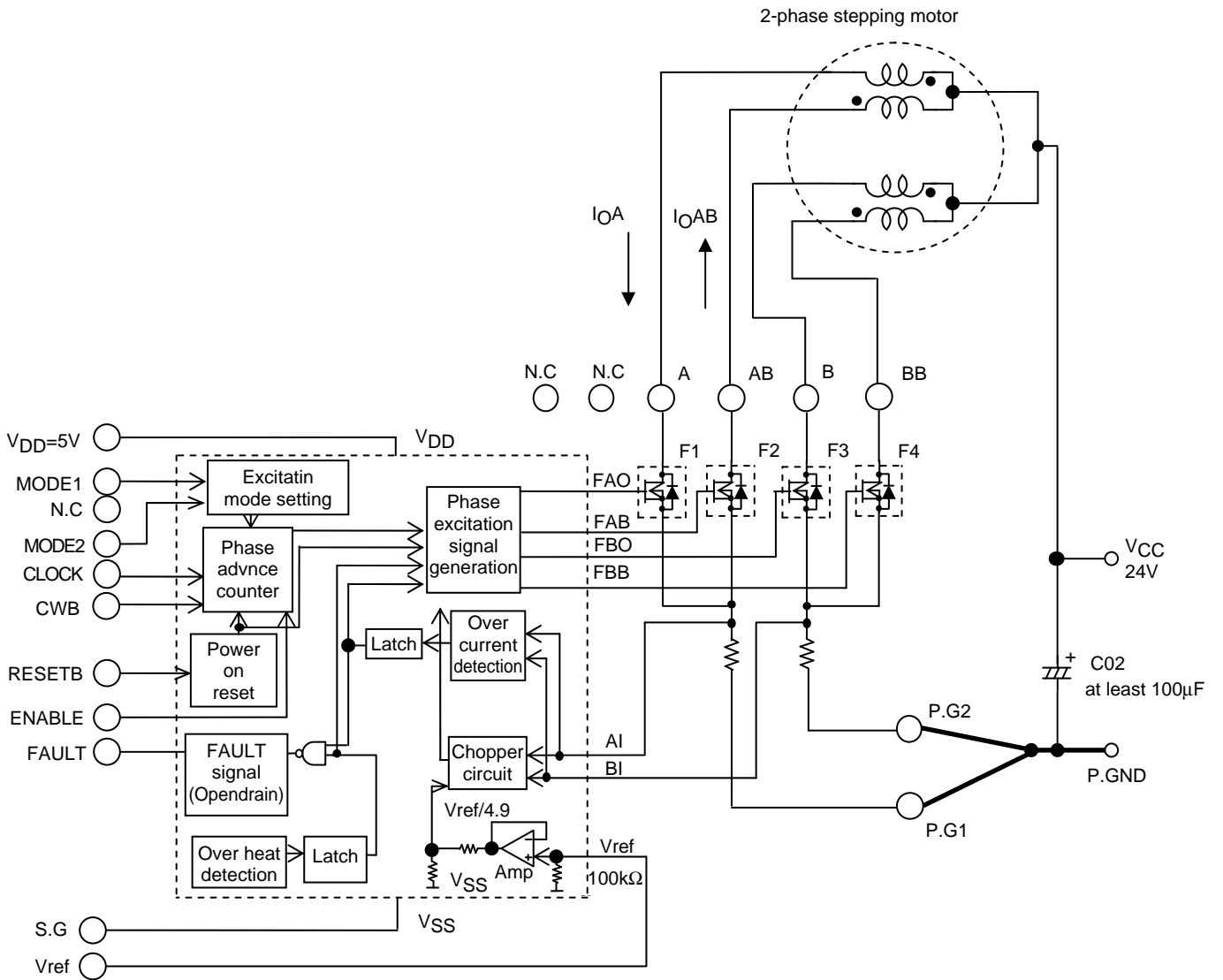
Package power loss, PdPK, refers to the average internal power loss, PdAV, allowable without a heat sink. The figure below represents the allowable power loss, PdPK, vs. fluctuations in the ambient temperature, Ta. Power loss of up to 2.8W is allowable at Ta=25°C, and of up to 1.5W at Ta=60°C.

Allowable power dissipation, PdPK(no heat sink) - Ambient temperature, Ta



STK672-642A-E

7. Example of Stepping Motor Driver Output Current Path (1-2 phase excitation)



- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of November, 2009. Specifications and information herein are subject to change without notice.